



W3000 PLL Dual-Band Frequency Synthesizer

Features

- 2.2 GHz operational
- Dual-band optimized
- Low supply current (5.1 mA)
- Surface-mount 14-pin TSSOP package
- Scaled PD gain for dual-band operation
- Programmable phase-detector polarity
- Synchronous or forced counter update loading
- Powerdown mode via external pin or serial bus
- Low-load capacitance on reference input buffer

Applications

- GSM900/1800/1900
- North American IS-136/137
- Personal Digital Cellular (Japan RCR-27)
- Personal Handy Phone (Japan RCR-28)
- CDMA (IS-95)

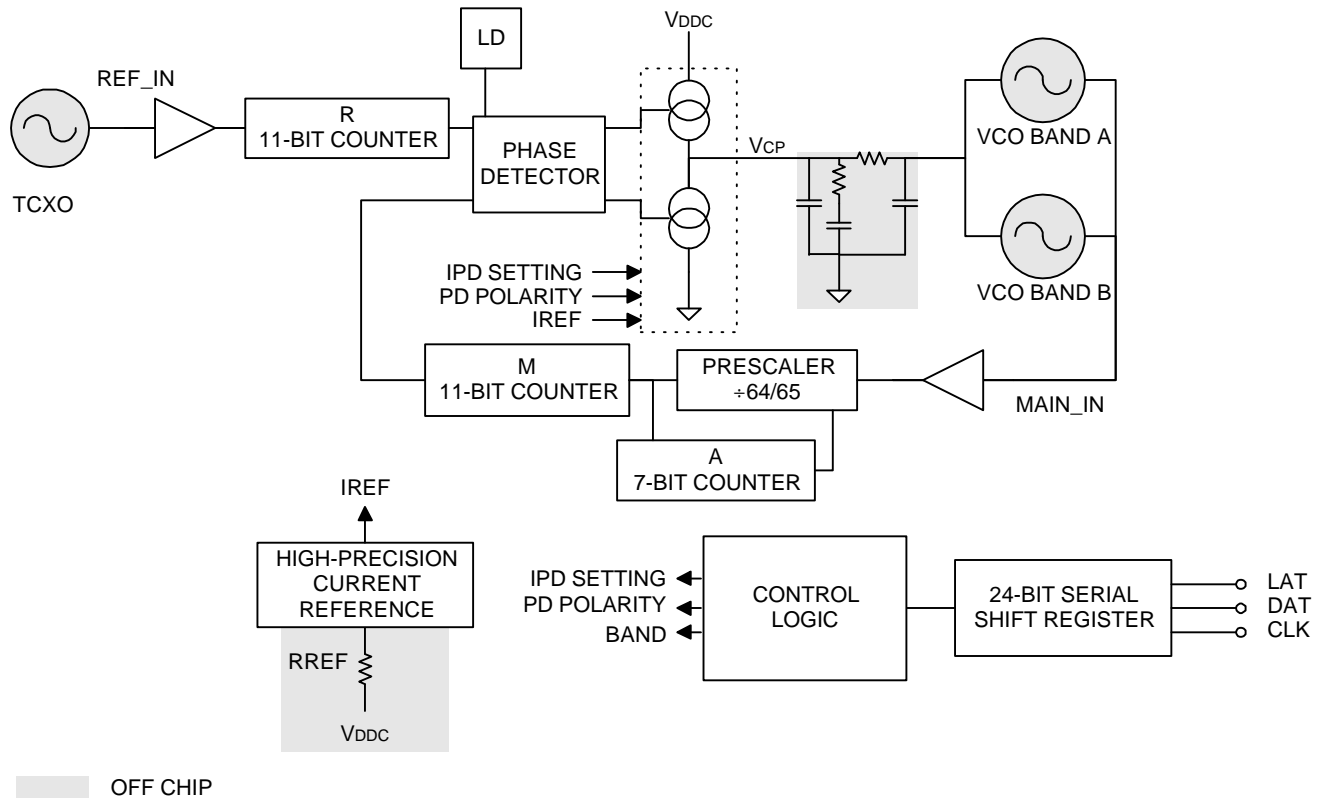


Figure 1. Block Diagram with Pinout

Table of Contents

Features.....	1
Applications	1
Description.....	3
Pin Information.....	4
Absolute Maximum Ratings.....	5
Electrostatic Discharge Caution.....	5
Electrical Characteristics.....	6
Charge Pump Current	7
PLL Programming Information	8
Serial Data Input	9
Serial Bus Timing Information	9
Functional Descriptions	10
REF Register	11
MAIN Register.....	15
PLL Lock-Detect Function	17
Typical Performance Characteristics	17
MAIN_IN Input Parallel Equivalent Circuit.....	18
Application Example	18
Application Information	19
Typical Performance Data.....	22
Outline Diagram.....	26
14-Pin TSSOP.....	26
Manufacturing Information	27
Ordering Information	27

Pin Information

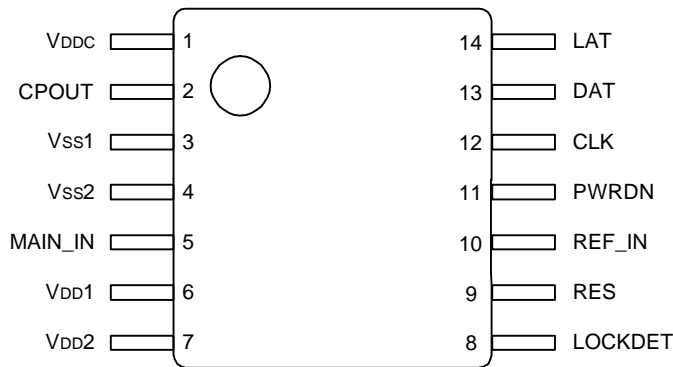


Figure 3. Pin Diagram

Table 1. Pin Descriptions

Pin	Symbol	Function	Name/Description
1	VDDC	Supply	Charge Pump Positive Supply Voltage. Must be $\geq VDD$. ($VDD = VDD1 = VDD2$).
2	CPOUT	Output	Charge Pump Output.
3	Vss1	Ground	Ground 1. Charge pump and logic ground.
4	Vss2	Ground	Ground 2. Prescaler and reference ground.
5	MAIN_IN	Input	VCO Signal Input. Must be ac-coupled.
6	VDD1	Supply	Voltage Supply 1. Prescaler supply voltage.
7	VDD2	Supply	Voltage Supply 2. Logic and reference supply (must be equal to VDD1).
8	LOCKDET	Output	Lock Detect Output.
9	RES	Input	External Resistor Input. Add resistor to VDDC if required ($>10\text{ k}\Omega$).
10	REF_IN	Input	Reference Frequency Input. Connection from reference oscillator. Must be ac-coupled.
11	PWRDN	Input	Powerdown. For low current operation. (Low is powerdown mode.)
12	CLK	Input	Serial Input. Programming clock line.
13	DAT	Input	Serial Input. Programming data line.
14	LAT	Input	Serial Input. Programming latch line.

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Parameter	Symbol	Min	Max	Unit
Ambient Operating Temperature	T _A	-30	85	°C
Storage Temperature	T _{stg}	-65	150	°C
Lead Temperature (soldering, 10 s)	T _L	—	300	°C
Positive Supply Voltage	V _{DD}	0	4.5	Vdc
Positive Charge Pump Supply Voltage	V _{DDC}	0	4.5	Vdc
Power Dissipation	P _D	—	250	mW
ac Input Voltage	—	0	V _{DD}	Vp-p
Digital Voltages	—	V _{SS} - 0.3	V _{DD} + 0.3	Vdc

Electrostatic Discharge Caution

Although protection circuitry has been designed into this device, proper precautions should be taken to avoid exposure to electrostatic discharge (ESD) during handling and mounting. Lucent Technologies Microelectronics Group employs a human-body model (HBM) and a charged-device model (CDM) for ESD-susceptibility testing and protection design evaluation. ESD voltage thresholds are dependent on the circuit parameters used to define the model. No industry-wide standard has been adopted for CDM. However, a standard HBM (resistance = 1500 Ω, capacitance = 100 pF) is widely used and, therefore, can be used for comparison purposes.

Parameter	Model	Min	Max	Unit
ESD Threshold Voltage	HBM	1000	—	V
ESD Threshold Voltage (corner pins)	CDM	1000	—	V
ESD Threshold Voltage (noncorner pins)	CDM	1500	—	V

Electrical Characteristics

Table 2. General Specifications

Conditions (unless otherwise specified): $V_{DD} = 2.7\text{ V}$; $T_A = 25\text{ }^\circ\text{C} \pm 3\text{ }^\circ\text{C}$; $V_{REF} = 0.25\text{ Vp-p}$, $V_{DDC} = 2.85\text{ V}$.

Parameters	Symbol	Min	Typ	Max	Unit
Ambient Operating Temperature	T_A	-30	25	85	$^\circ\text{C}$
Nominal Operating Voltage	V_{DD}	2.7	2.85	3.6	V
Nominal Charge Pump Operating Voltage	V_{DDC}	V_{DD}	2.85	3.6	V
Power Supply Current [†]	I_{DD}	—	5.1	8.0	mA
Powerdown Current [†]	I_{DD}	—	0.1	20	μA
Digital Inputs:					
Logic High Voltage	V_{IH}	$0.7 * V_{DD}$	V_{DD}	$V_{DD} + 0.15$	V
Logic Low Voltage	V_{IL}	-0.3	GND	$0.3 * V_{DD}$	V
Logic High Current ($V_{IH} = V_{DD} + 0.15\text{ V}$)	$ I_{IH} $	—	—	10	μA
Logic Low Current ($V_{IL} = -0.3\text{ V}$)	$ I_{IL} $	—	—	10	μA
Digital Outputs:					
Logic High Voltage ($ I_{OH} = 2\text{ mA}$)	V_{OH}	$V_{DD} - 0.4$	—	—	V
Logic Low Voltage ($ I_{OL} = 2\text{ mA}$)	V_{OL}	—	—	0.4	V

[†] ($I_{DD1} + I_{DD2} + I_{DDC}$) under locked condition, $V_{DDC} = 2.85\text{ V}$; $f_{VCO} = 1200\text{ MHz}$; $f_{REF} = 13\text{ MHz}$.[‡] ($I_{DD1} + I_{DD2} + I_{DDC}$) $V_{IL} = 0\text{ Vdc}$ on all logic input pins.

Table 3. Electrical Specifications

Conditions (unless otherwise specified): $V_{DD} = 2.7\text{ V}$; $T_A = 25\text{ }^\circ\text{C} \pm 3\text{ }^\circ\text{C}$; $V_{REF} = 0.25\text{ Vp-p}$, $V_{DDC} = 2.85\text{ V}$.

Parameter	Symbol	Min	Typ	Max	Unit
Main Input Frequency Range	f_{VCO}	0.5	—	2.2	GHz
Main Input Level (1100 MHz—1750 MHz)	V_{MAIN}	-20	—	6	dBm/50 Ω^*
Main Input Level [†]	V_{MAIN}	-10	—	6	dBm/50 Ω^*
Reference Input Frequency Range	f_{REF}	8	—	30	MHz
Reference Input Shunt Resistance	—	20	30	—	k Ω
Reference Input Shunt Capacitance	—	—	1.2	3	pF
Reference Input Slew Rate	—	41	60	—	mV/ns
Reference Input Level	V_{REF}	0.25	—	2.00	Vp-p
Phase Detector Comparison Frequency	f_{COMP}	0.025	—	2	MHz
External Resistor Value (pin 9 to V_{DDC})	—	10	18	—	k Ω
Phase Detector Range	—	-2π	—	2π	rad.
Phase Detector Noise Floor, $\pm 150\text{ Hz}$ offset (25 kHz comparison frequency) [‡]	—	—	-167	—	dBc/Hz

*Equivalent voltage of a 50 Ω terminated source.[†] Frequencies outside the 1100 MHz—1750 MHz range and up to and including 2200 MHz.[‡] $f_{VCO} = 1190\text{ MHz}$; $V_{REF} = 1.4\text{ Vp-p}$.

Charge Pump Current

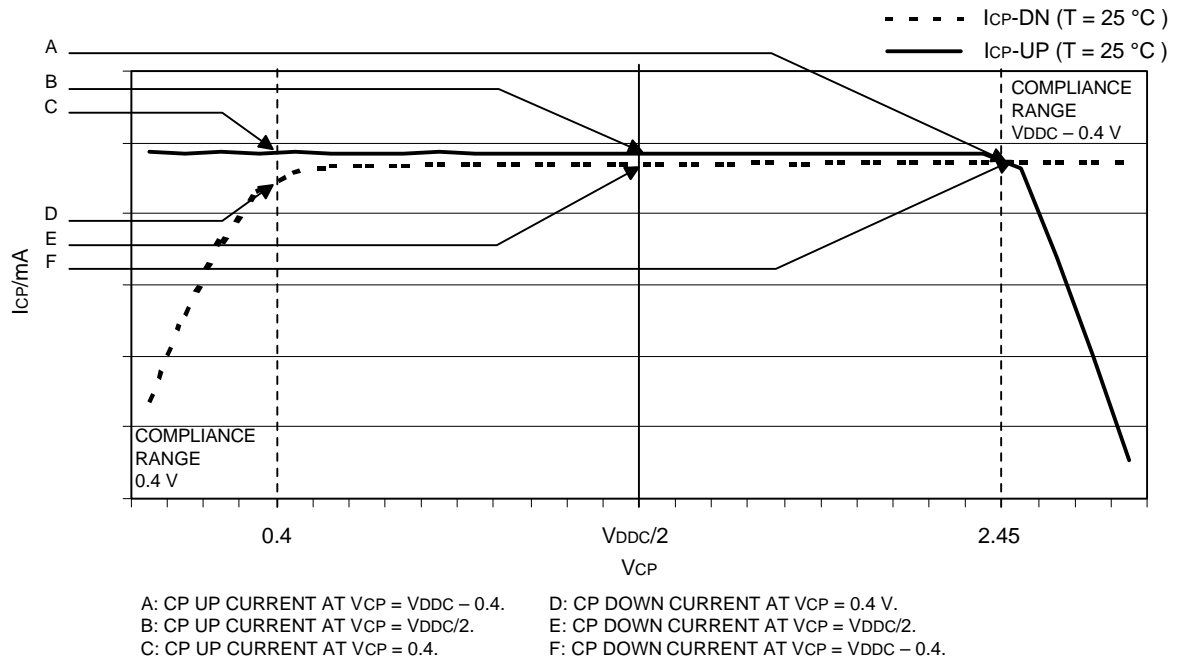


Figure 4. Charge Pump Current vs. Voltage

Table 4. Charge Pump Specifications

Conditions (unless otherwise specified): V_{DD} = 2.7 V; T_A = 25 °C ± 3 °C; V_{DDC} = 2.85 V; V_{CP} = V_{DDC}/2; R_{REF} = 18 kΩ.

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Charge Pump Output Current	I _{CP} = 0.7 mA	I _{UP}	0.6	0.7	0.8	mA
	I _{CP} = 0.7 mA	I _{DN}	-0.8	-0.7	-0.6	mA
	I _{CP} = 0.9 mA	I _{UP}	0.8	0.9	1.0	mA
	I _{CP} = 0.9 mA	I _{DN}	-1.0	-0.9	-0.8	mA
	I _{CP} = 1.9 mA	I _{UP}	1.6	1.9	2.2	mA
	I _{CP} = 1.9 mA	I _{DN}	-2.2	-1.9	-1.6	mA
	I _{CP} = 2.5 mA	I _{UP}	2.1	2.5	2.9	mA
	I _{CP} = 2.5 mA	I _{DN}	-2.9	-2.5	-2.1	mA
CP High-Impedance State Current	0.4 ≤ V _{CP} ≤ V _{DDC} - 0.4 V, -30 °C < T _A < +85 °C	I _{TRI}	—	0.1	20	nA
CP Sink vs. Source Mismatch ¹	T _A = 25 °C	—	—	3	15	%
CP Current vs. Voltage ²	0.4 ≤ V _{CP} ≤ V _{DDC} - 0.4 V, T _A = 25 °C	—	—	2	8.5	%
CP Current vs. Temperature ³	-30 °C < T _A < +85 °C	—	—	8	10	%

Notes (refer to Figure 4 for definitions):

1. ICP-DN vs ICP-UP = charge pump output current up vs down mismatch = $\frac{|E| - |B|}{1/2 * (|E| + |B|)} * 100\%$.

2. ICP vs VCP = charge pump output current magnitude variation vs voltage = $\frac{1/2 * (|F| - |D|)}{1/2 * (|F| + |D|)} * 100\%$ and $\frac{1/2 * (|A| - |C|)}{1/2 * (|A| + |C|)} * 100\%$.

3. ICP vs T_A = charge pump output current magnitude variation vs. temperature = $\frac{|E @ temp| - |E @ 25 °C|}{|E @ 25 °C|} * 100\%$ and $\frac{|B @ temp| - |B @ 25 °C|}{|B @ 25 °C|} * 100\%$.

PLL Programming Information

The oscillator frequency is selected according to the following expression:

$$f_{VCO} = \frac{[(P * M) + A] * f_{REF}}{R}$$

where:

f_{VCO} = VCO frequency

$P/(P + 1)$ = Dual modulus prescaler

M = Programmable counter ratio (2 to 2047), $M > A$

A = Swallow counter ratio (0 to $M - 1$ or 127)

f_{REF} = External reference oscillator frequency

R = Reference counter ratio (2 to 2047)

Example

You wish to have a VCO operating at 1172 MHz, ability to step the frequency in 200 kHz steps, and a reference clock at 13 MHz.

Step 1:

Calculate the reference counter ratio R

$$R = \frac{13 \text{ MHz}}{200 \text{ kHz}} = 65$$

Step 2: Calculate M & A

$$f_{VCO} = \frac{[(P * M) + A] * f_{REF}}{R}$$

$$1172 = \frac{[(64 * M) + A] * 13}{65}$$

$$(64 * M + A) = \frac{1172 * 65}{13} = 5860$$

$$\frac{5860}{64} = 91 \frac{36}{64}$$

M is an integer, and so is A ; therefore, $M = 91$, and $A = 36$.

Serial Data Input

The PLL is programmed via a 3-wire serial bus, utilizing a data pin (DAT), a clock pin (CLK), and a latch pin (LAT).

Serial Bus Timing Information

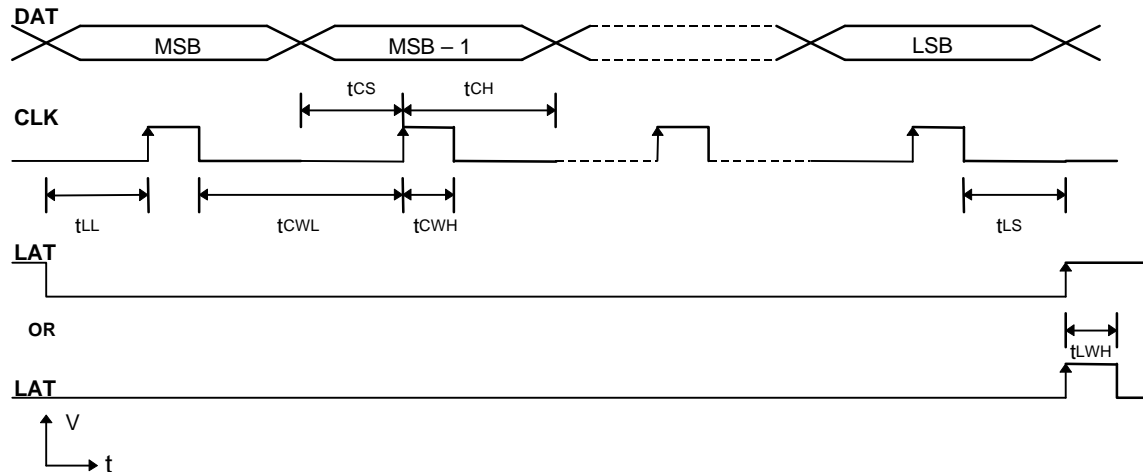


Figure 5. Serial Bus Timing Diagram

Table 5. Serial Bus Timing Information

Symbol	Parameter	Min	Typ	Max	Unit
tCS	Data to Clock Setup Time	33	—	—	ns
tCH	Data to Clock Hold Time	10	—	—	ns
tCWH	Clock Pulse Width High	33	—	—	ns
tCWL	Clock Pulse Width Low	33	—	—	ns
tLS	Clock Falling Edge to Latch High Setup Time	0	—	—	ns
tLWH	Latch Pulse Width	50	—	—	ns
tLL	Latch to Clock Setup Time	33	—	—	ns
fCLK	Clock Input Frequency	—	—	10	MHz

Functional Descriptions

The W3000 contains a reference register (REF) and a main register (MAIN). The REF register is used for programming the division ratio of the reference clock and for initial setup of the operation modes. The MAIN register is intended for programming that can occur frequently, e.g., dynamic channel switching and putting the W3000 into power-saving mode.

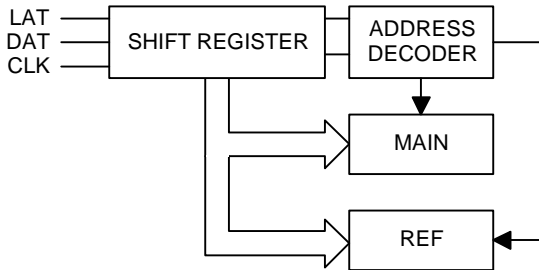


Figure 6. Register Programming Diagram

Both REF and MAIN registers are programmed separately, each with a 24-bit data sequence. The last bit is that which immediately precedes a low-to-high latch input transition occurring while the CLOCK input is low. Bit 24 is loaded first, and bit 1 is loaded last. The last bit in the serial sequence is C0. This bit is used to direct the 24-bit sequence to the MAIN or REF registers.

Table 6. C0:C1: MAIN and REF Register Addressing (Destination of Serial Data) (Bits 1 and 24)

C1	C0	Addressed Register
0	0	MAIN
0	1	REF
1	0	Secondary Address
1	1	Secondary Address

The first bit, C1, allows the W3000 to share the serial bus. When C1 is a logic high, the W3000 ignores the data sent on the serial bus.

REF Register

This section describes each bit of the reference register. The REF register is used for programming the division ratio of the reference clock and for initial setup of the operation modes.

Table 7. REF Register Bit Description (C0 = 1, C1 = 0)

Bit	Name	Description
1	C0 = 1	Register address bit. C0 = 1 for REF (last bit in serial sequence).
2:12	R[1:11]	Reference frequency divide ratio.
13	D1	Forced counter reload programming (synchronous/asynchronous).
14	D2	Charge pump disable function.
15:16	D3, D4	Programmable charge pump current for frequency band 2.
17	D5	Phase detector polarity.
18:19	D6, D7	Programmable charge pump current for frequency band 1.
20	RE	Reset for first programming after powerup (1 = reset).
21	ERES	Enables external resistor (on RES pin) to set charge pump current.
22	EN1	Enable W3000. (0 is powerdown.)
23	LD	Lock detect output enable.
24	C1 = 0	Secondary address bit (first bit in serial sequence).

Table 8. REF Register

Last bit in serial sequence ↙											First bit in serial sequence ↘												
1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24
C0 = 1	R 1	R 2	R 3	R 4	R 5	R 6	R 7	R 8	R 9	R 10	R 11	D 1	D 2	D 3	D 4	D 5	D 6	D 7	RE	ERES	EN	LD	C1 = 0

Table 9. R1:R11: Reference Divider Ratio (Bits 2 to 12)

R11	R10	R9	R8	R7	R6	R5	R4	R3	R2	R1	Divide Ratio R
—	—	—	—	—	—	—	—	—	—	—	—*
0	0	0	0	0	0	0	0	0	1	0	2
0	0	0	0	0	0	0	0	0	1	1	3
.
.
.
1	1	1	1	1	1	1	1	1	1	1	2047

*The reference counter cannot operate with division numbers less than 2.

REF Register (continued)**Table 10. D1: Forced Counter Reload (Bit 13)**

D1	Response
0	Synchronous counter reloading update
1	Forced counter reload (M, R, A)

With synchronous reloading, the counter reloads a new programmed value when the counter reaches zero. With forced counter reloading, the reloading occurs when the programmed word is latched in. This can improve lock time when performing a dual-band hop.

Table 11. D2: Charge Pump Off Mode (Bit 14)

D2	Response
0	Charge pump enabled
1	Charge pump off (high impedance)

This allows the disabling of the charge pump for systems that directly modulate an open-loop VCO.

Table 12. Band and Charge Pump Current (Band 1, Bits 18 and 19; Band 2, Bits 15 and 16)

Band	D3 Bit 15	D4 Bit 16	D6 Bit 18	D7 Bit 19	Charge Pump Current ISET
1	x	x	0	0	0.7 mA
1	x	x	1	0	0.9 mA
1	x	x	0	1	1.9 mA
1	x	x	1	1	2.5 mA
2	0	0	x	x	0.7 mA
2	1	0	x	x	0.9 mA
2	0	1	x	x	1.9 mA
2	1	1	x	x	2.5 mA

The charge pump current is selected by bit 23 of the MAIN register. Setting bit 23 to a 0 will select band 1, which is established with bits 18 and 19 of the REF register. Likewise, setting bit 23 to a 1 will select band 2, which is established with bits 15 and 16 of the REF register. This allows the charge pump current to be dynamically changed along with the VCO frequency.

The PLL loop natural frequency is proportional to charge pump current and inversely proportional to the N count. Therefore, when the ratio of charge pump current and VCO frequency is the same, the loop natural frequency does not change. This allows the same loop filter to be used for two different VCO frequencies. For example, in a GSM900/1800 system with VCOs running at 1190 MHz/1570 MHz, the current could be set to 1.9 mA for GSM900 and 2.5 mA for GSM 1800 to compensate for the change in division ratios. The current setting may also be determined by an external resistor. (See Table 15.) In that case, the ratio between the currents programmed will stay the same, but the absolute level will be resistor-dependent.

REF Register (continued)

Table 13. D5: Phase Detector Polarity (Bit 17)

D5	Phase Detector Polarity
0	Negative slope
1	Positive slope

The phase detector can be programmed for either a negative or positive slope to accommodate the VCO and low-pass filter characteristics. (See Figure 7.)

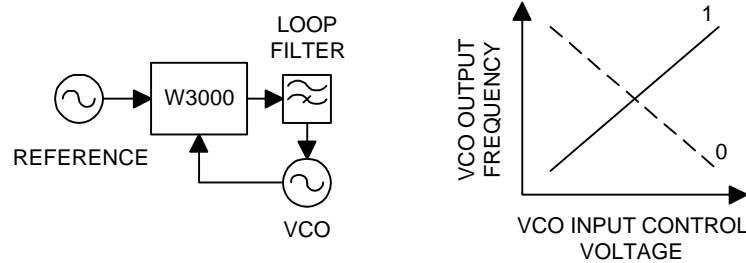


Figure 7. Programming the Phase Detector Slope

Table 14. RE: Reset (Bit 20)

RE	Response
0	Operation mode
1	Reset MAIN and secondary registers

After the power supply is turned on, the REF register must be programmed with a reset. This must be followed by a programming of the MAIN register before or at the enabling of the PLL circuit.

The RE bit will clear itself, and is required to ensure correct initialization of the IC. This results in the following conditions:

- The RE bit is cleared back to 0.
- The device is in powerdown mode, since the EN[1:2] bits are also cleared.
- Previous reference and main counter values are maintained.

REF Register (continued)**Table 15. ERES: External Resistor Setting for Charge Pump Current (Bit 21)**

ERES	External Resistor Status
0	Use internal charge pump current setting (not tested in production)
1	Use external resistor to set charge pump current (recommended)

If bit 21 is set to 0, the W3000 uses its internal current source to set the charge pump currents, with the values shown in Table 12. If bit 21 is set to 1, the charge pump current is set by an external resistor between pin 9 (RES) and VDDC. In this case, the charge pump current is given by the following formula:

$$I_{CP} = I_{SET} * \frac{V_{DDC} - 1.05}{100 \mu A * R_{REF}}$$

where

I_{CP} = Nominal charge pump current.

I_{SET} = Current setting as in Table 12.

R_{REF} = Value of external current reference resistor. See Table 3 for appropriate value.

A tight-tolerance R_{REF} resistor is recommended.

Table 16. EN1: Synthesizer Enable (Bit 22)

PWRDN (Input Pin 11)	EN1	Mode
High	0	Powerdown
High	1	Enable
Low	0	Powerdown
Low	1	Powerdown

The MAIN register also contains an enable bit, EN2. The W3000 is enabled and powered down with either the REF or the MAIN register, whichever was programmed more recently. The contents of the MAIN and REF registers are maintained in powerdown mode, providing supply voltages are maintained.

Table 17. LD: Lock Detect Enable (Bit 23)

LD (Bit 23)	Mode	PLL Condition	Output Level on Pin 8 LockDet
0	Disabled	Locked	High
0	Disabled	Unlocked	High
1	Enabled	Locked	High
1	Enabled	Unlocked	Low

MAIN Register

The MAIN register is intended for programming that can occur frequently for dynamic channel switching and putting the W3000 into power-saving mode.

Table 18. MAIN Register Bit Description (C0 = 0, C1 = 0)

Bit	Name	Description
1	C0 = 0	Register address bit. C0 = 0 for MAIN (last bit in serial sequence).
2:8	A[1:7]	Swallow counter for prescaler modulus control.
9:19	M[1:11]	Main counter.
20	Reserved	—
21	Reserved	—
22	EN2	Enable all PLL circuits (0 = powerdown mode).
23	B	Band select for charge pump current control (band 1 = 0, band 2 = 1).
24	C1 = 0	Secondary address bit.

Table 19. MAIN Register

↙ Last bit in serial sequence
First bit in serial sequence ↘

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24
C0 = 0	A 1	A 2	A 3	A 4	A 5	A 6	A 7	M 1	M 2	M 3	M 4	M 5	M 6	M 7	M 8	M 9	M 10	M 11	X	X	EN	B	C1 = 0

Note: X bits are don't care bits.

Table 20. A1:A7: Swallow Counter Count (Bits 2 to 8)

A7 Bit 8	A6 Bit 7	A5 Bit 6	A4 Bit 5	A3 Bit 4	A2 Bit 3	A1 Bit 2	Counter Ratio
0	0	0	0	0	0	0	0
0	0	0	0	0	0	1	1
0	0	0	0	0	1	0	2
.
.
0	1	1	1	1	1	1	63
.
.
1	1	1	1	1	1	1	127

W3000 PLL Dual-Band Frequency Synthesizer

MAIN Register (continued)

Table 21. M1:M11: Programmable Main Counter Divide Ratio (Bits 9 to 19)

M11 Bit 19	M10 Bit 18	M9 Bit 17	M8 Bit 16	M7 Bit 15	M6 Bit 14	M5 Bit 13	M4 Bit 12	M3 Bit 11	M2 Bit 10	M1 Bit 9	Divide Ratio M
0	0	0	0	0	0	0	0	0	1	0	2
0	0	0	0	0	0	0	0	0	1	1	3
.
.
.
0	0	0	1	1	1	1	1	1	1	1	255
.
.
.
1	1	1	1	1	1	1	1	1	1	1	2047

The main counter divides the frequency of the prescaler output signal and sources the divided signal to the phase comparator.

Table 22. EN2: Synthesizer Enable (Bit 22)

PWRDN	EN2	Mode
H	0	Powerdown
H	1	Enable
L	0	Powerdown
L	1	Powerdown

The REF register also contains an enable bit, EN1 (see Table 16). The W3000 is enabled or powered down with either the REF or MAIN register, whichever was programmed more recently. The contents of the MAIN and REF registers are maintained in powerdown mode, providing supply voltages are maintained.

Table 23. B: Band Select (Bit 23)

B	Band
0	Band 1
1	Band 2

In dual-band operation, this bit allows the use of one loop filter by setting the charge pump current to correspond to the frequency of the band selected. See Table 12 for the available charge pump current settings.

W3000 PLL Dual-Band Frequency Synthesizer

MAIN_IN Input Parallel Equivalent Circuit

The input impedance is high, and can best be represented by the model shown in Figure 9.

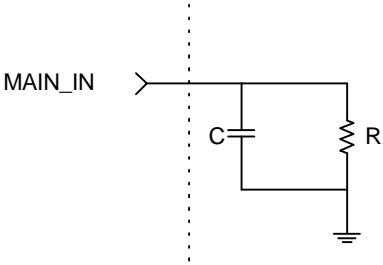


Figure 9. MAIN_IN Parallel Equivalent Circuit

Table 24. MAIN_IN Input Parallel Equivalent Circuit Values

Frequency (MHz)	C (pF)	R (Ω)
600	0.88	3680
800	0.87	2650
1000	0.85	2370
1200	0.85	1970
1400	0.86	1580
1600	0.92	1230
1800	1.00	740
2000	1.10	590
2200	1.20	480

Application Example

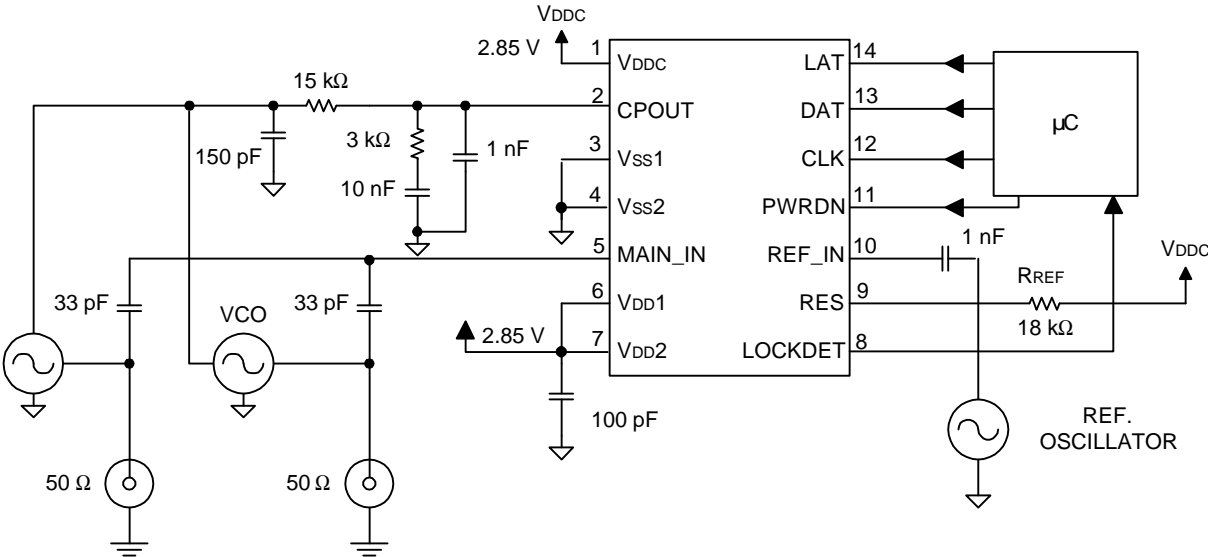


Figure 10. Application Circuit Diagram

Downloaded from Elcodis.com electronic components distributor

Application Information

A typical PLL system can be modeled as follows:

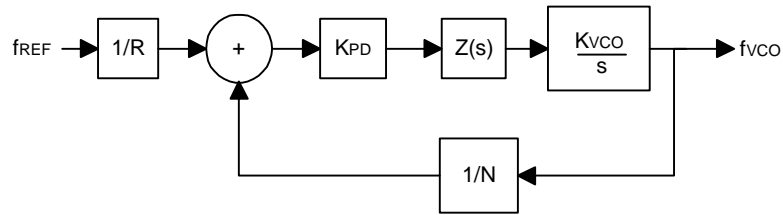


Figure 11. Typical PLL Model

K_{PD} = Phase detector in $\text{mA}/2\pi$ rad

$Z(s)$ = Loop filter

K_{VCO} = VCO gain in MHz/V

N = Total divide ratio

R = Reference divide ratio

Where the open loop gain is:

$$G(s)_{\text{OPEN}} = \frac{K_{PD} * Z(s) * K_{VCO}}{Ns}$$

Where

$$s = j\omega$$

The circuit shown in Figure 12 uses a passive third-order loop filter for the element $Z(s)$, defined by the network:

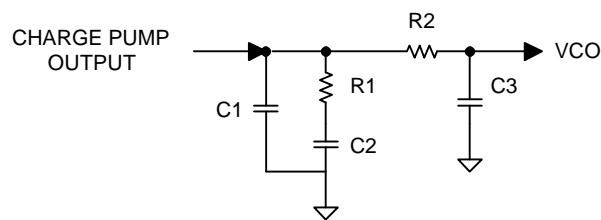


Figure 12. Third-Order Loop Filter

The purpose of the loop filter is to provide response with bandwidth sufficient not only to allow a quick lock time but also to meet phase-noise and reference sideband requirements. Addition of a third pole formed by $R2$ and $C3$ will improve reference sideband performance with little overall impact on the loop performance. A reasonable practical limit is that the f comparison is greater than 5 times loop bandwidth.

Application Information (continued)

General rules for the values of these components have been derived many times¹, and are quoted here merely for reference. If:

$$T1 = \frac{\sec \phi - \tan \phi}{\omega_p}$$

$$T2 = \frac{1}{\omega_c^2 * (T1 + T3)}$$

$$T3 = \sqrt{\frac{10^{\text{atten}/20} - 1}{(2\pi * F_{\text{REF}})^2}}$$

where

ϕ = Phase margin required, normally 45° for a critically damped response.

ω_p = Loop bandwidth.

ω_c = Loop bandwidth modified for extra pole of R3 and C3, as described by:

$$\omega_c = \frac{\tan \phi * (T1 + T3)}{(T1 + T3)^2 + (T1 * T3)} * \left[\sqrt{1 + \frac{(T1 + T3)^2 + (T1 * T3)}{[\tan \phi * (T1 + T3)]^2}} - 1 \right]$$

f_{REF} = Reference frequency.

atten = Attenuation provided by the third pole at the reference frequency.

The loop filter values can then be derived as:

$$C1 = \frac{T1}{T2} * \frac{K_{\text{PD}} * K_{\text{VCO}}}{\omega_c^2 * N} * \left[\frac{(1 + \omega_c^2 * T2^2)}{(1 + \omega_c^2 * T1^2)(1 + \omega_c^2 * T3^2)} \right]^{1/2}$$

$$C2 = C1 * \left(\frac{T2}{T1} - 1 \right)$$

$$R1 = \frac{T2}{C2}$$

The final pole, consisting of R2 and C3, should be chosen such that the following guidelines are followed:

$$C3 \leq \frac{C1}{10} \text{ and } R2 \geq 2 * R1$$

1. Rohde, Ulrich L., *Digital PLL Frequency Synthesizers Theory and Design*, Prentice-Hall, 1983.

Application Information (continued)

For example, take a GSM application where a loop bandwidth of 22 kHz is required.

Other parameters specified by the system are listed below:

Parameter	Value
VCO Gain (K _{VCO})	88 MHz/V
Charge Pump Current (I _{CP})	2.5 mA
Divider Ratio (value of midband frequency used) (N)	7850
Required Phase Margin	45°
Reference Frequency Attenuation from Additional Pole	20 dB

Using the formulas above, the three time constants can be calculated as follows:

$$T1 = 2.63697E - 10^{-6} \text{ s}$$

$$T2 = 3.14484E - 10^{-5} \text{ s}$$

$$T3 = 2.38732E - 10^{-6} \text{ s}$$

From these values, we can derive the initial component values as follows:

$$R1 = 2992 \Omega$$

$$C1 = 0.96 \text{ nF}$$

$$C2 = 10.5 \text{ nF}$$

If we choose R2 = 15 k Ω , then

$$C3 = 159 \text{ pF}$$

From these initial values, the loop filter components used in the application circuit can be derived through practical optimization.

Typical Performance Data

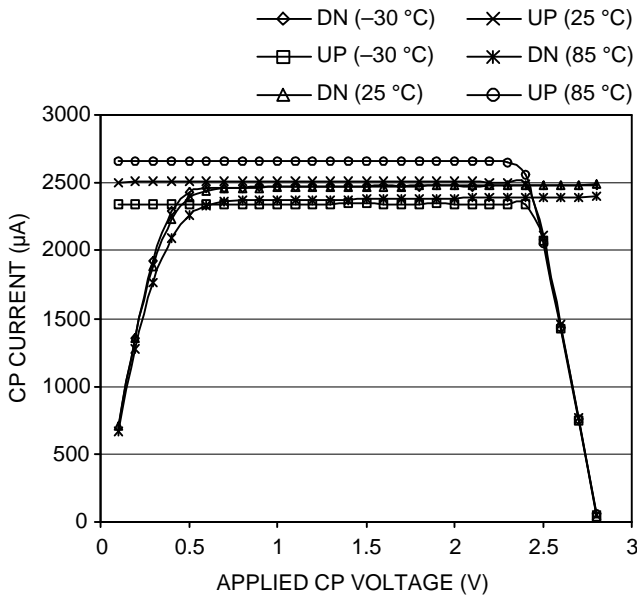


Figure 13. Charge Pump Current vs. Voltage and Temperature (2.5 mA)

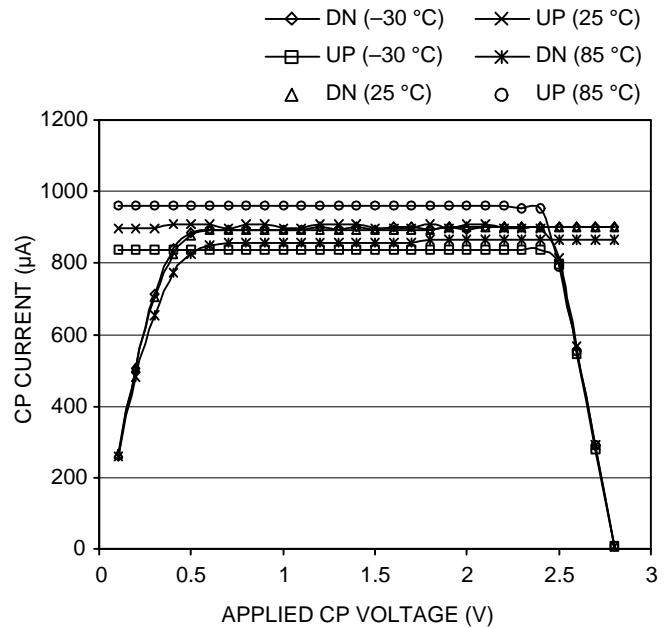


Figure 15. Charge Pump Current vs. Voltage and Temperature (0.9 mA)

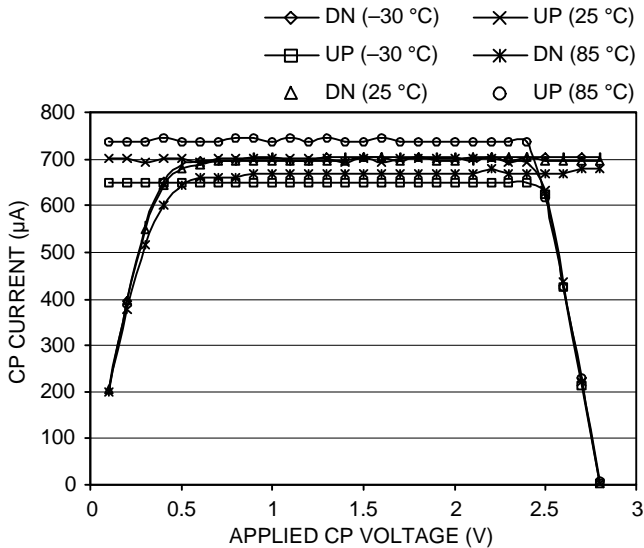


Figure 14. Charge Pump Current vs. Voltage and Temperature (0.7 mA)

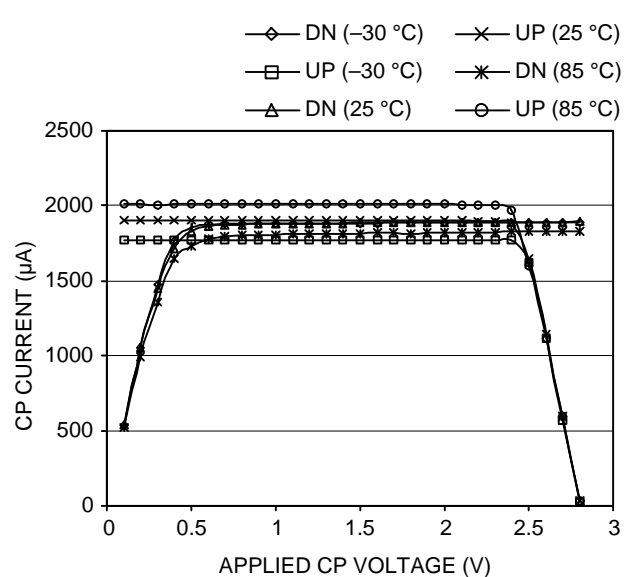


Figure 16. Charge Pump Current vs. Voltage and Temperature (1.9 mA)

Typical Performance Data (continued)

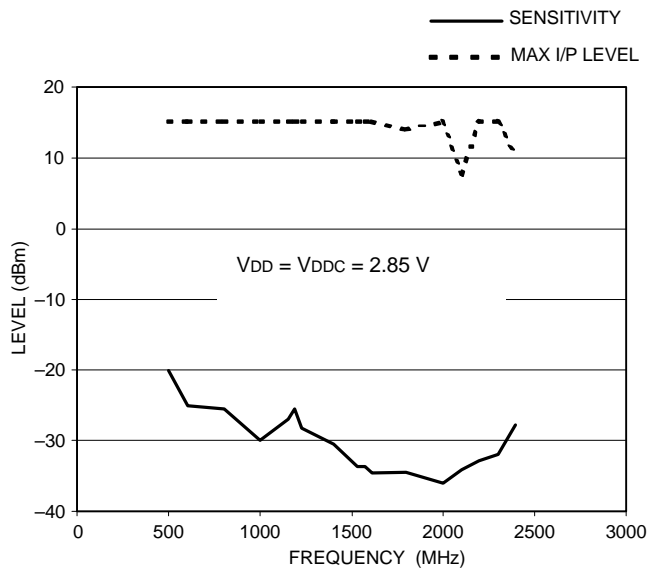


Figure 17. Prescaler Sensitivity and Maximum Input Level

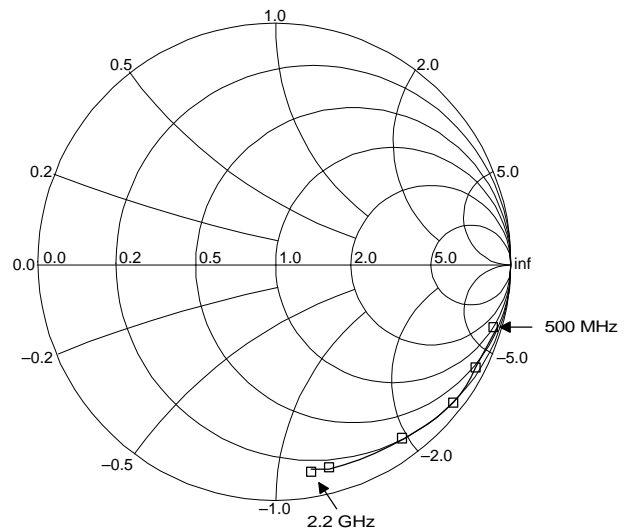


Figure 18. Input Impedance Smith Chart: 0.5 GHz to 2.2 GHz Frequency

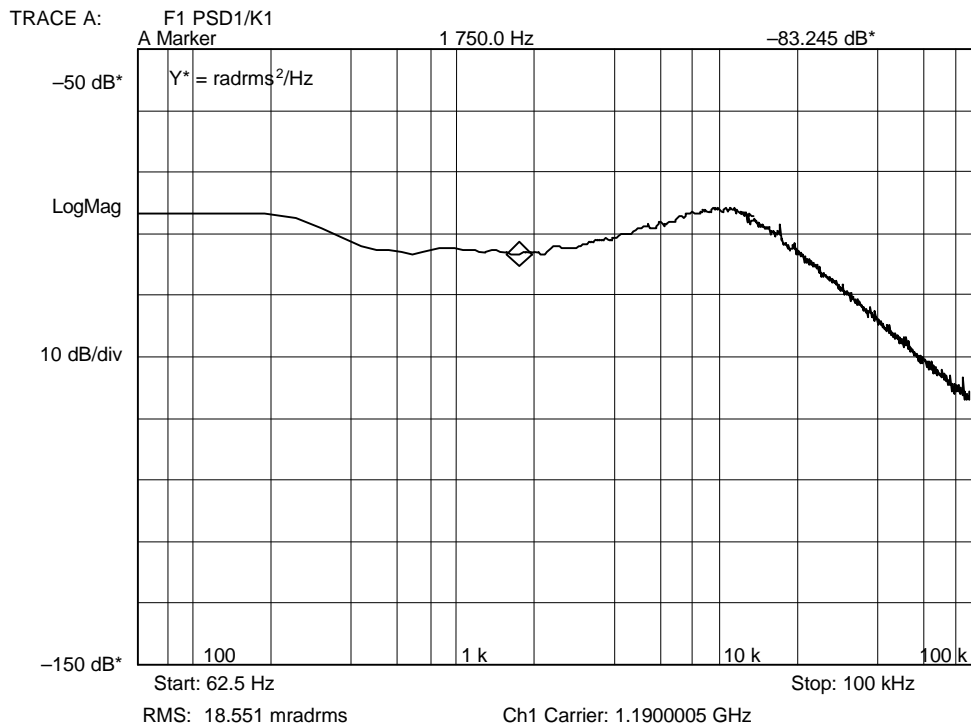


Figure 19. Phase Noise 1190 MHz, Fcomp = 200 kHz

Typical Performance Data (continued)

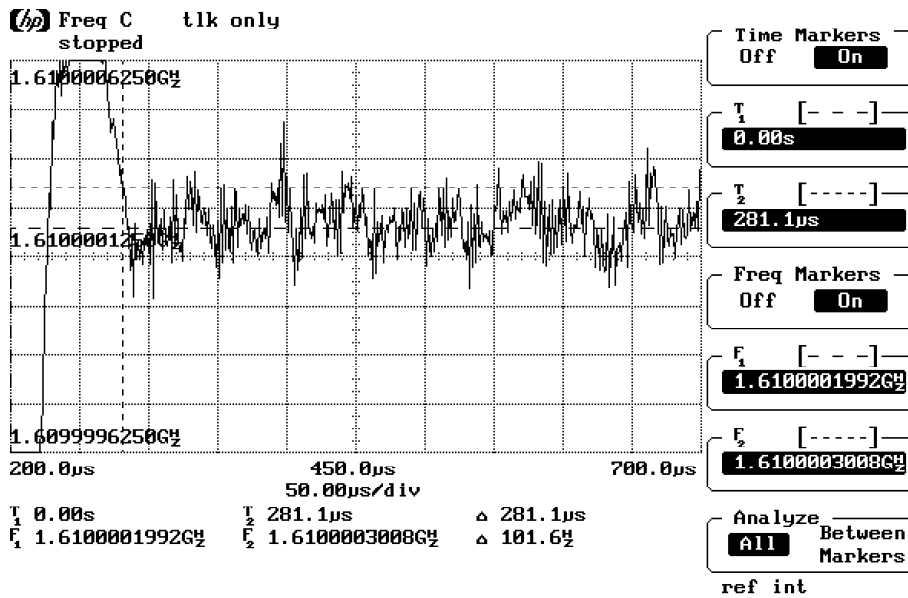


Figure 20. Settling Time from 1150 MHz to 1230 MHz ± 50 Hz

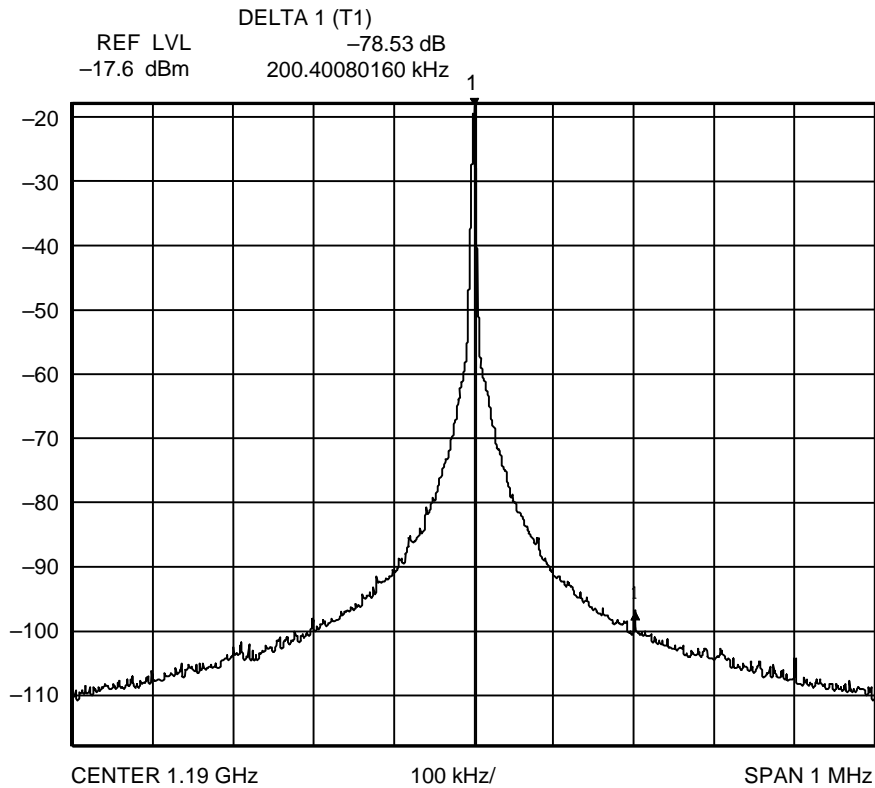


Figure 21. PLL Reference Spurs

Typical Performance Data (continued)

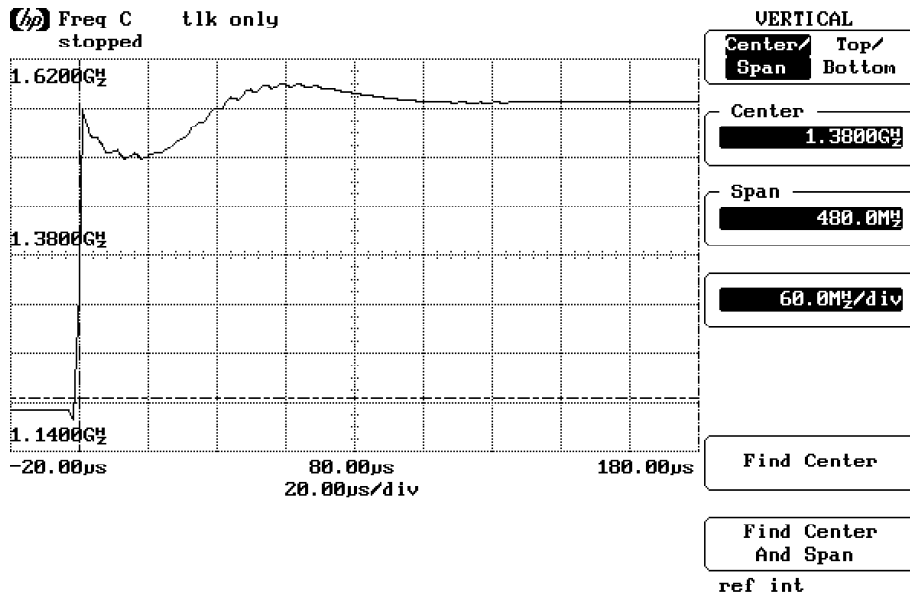
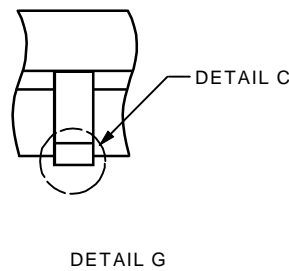
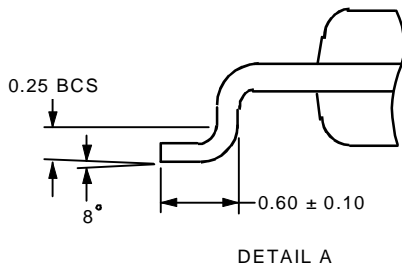
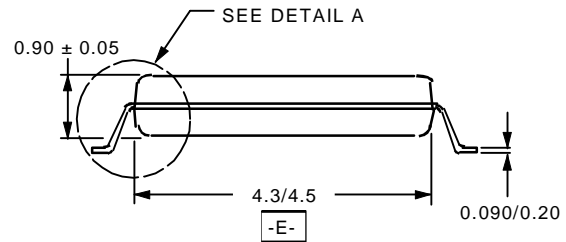
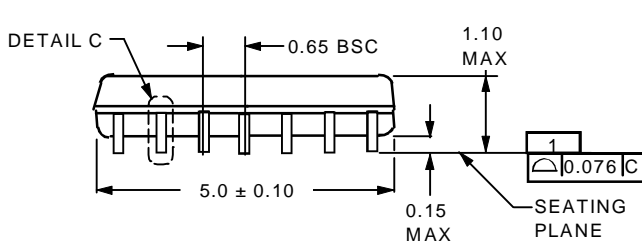
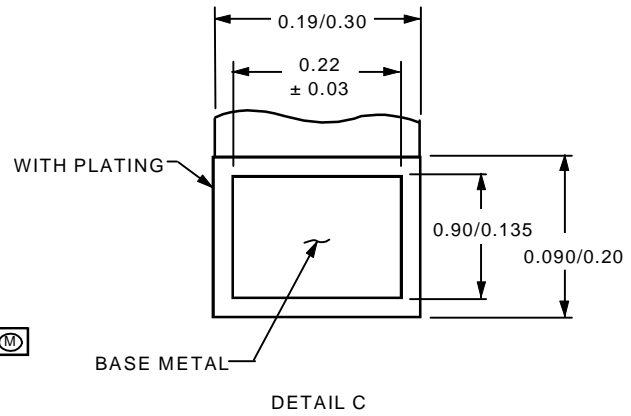
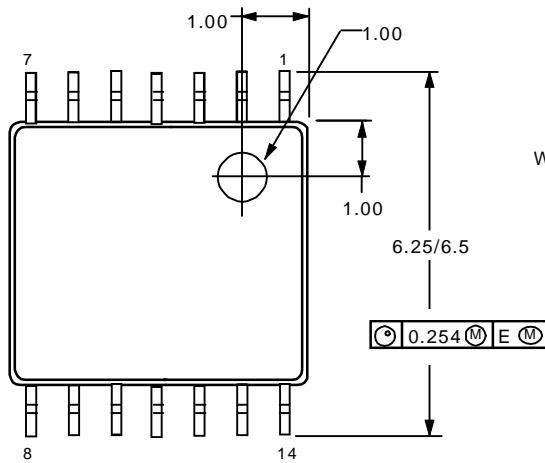


Figure 22. Dual-Band Locking

Outline Diagram

14-Pin TSSOP

Dimensions are in millimeters.



5-5462 C

Manufacturing Information

This device will be assembled in multiple locations, which include assembly codes P, M, and T.

Ordering Information

Device Code	Description	Package	Comcode
LUCW3000CCN	W3000 PLL Frequency Synthesizer Sticks	14-pin TSSOP	108417601
LUCW3000CCN-TR	W3000 PLL Frequency Synthesizer Tape and Reel	14-pin TSSOP	108417619

Note: Contact your Lucent Technologies Microelectronics Group Account Manager for minimum order requirements.

For additional information, contact your Microelectronics Group Account Manager or the following:

INTERNET: <http://www.lucent.com/micro>

E-MAIL: docmaster@micro.lucent.com

N. AMERICA Microelectronics Group, Lucent Technologies Inc., 555 Union Boulevard, Room 30L-15P-BA, Allentown, PA 18103
1-800-372-2447, FAX 610-712-4106 (In CANADA: **1-800-553-2448**, FAX 610-712-4106)

ASIA PACIFIC: Microelectronics Group, Lucent Technologies Singapore Pte. Ltd., 77 Science Park Drive, #03-18 Cintech III, Singapore 118256
Tel. (65) 778 8833, FAX (65) 777 7495

CHINA: Microelectronics Group, Lucent Technologies (China) Co., Ltd., A-F2, 23/F, Zao Fong Universe Building, 1800 Zhong Shan Xi Road, Shanghai 200233 P.R. China **Tel. (86) 21 6440 0468, ext. 316**, FAX (86) 21 6440 0652

JAPAN: Microelectronics Group, Lucent Technologies Japan Ltd., 7-18, Higashi-Gotanda 2-chome, Shinagawa-ku, Tokyo 141, Japan
Tel. (81) 3 5421 1600, FAX (81) 3 5421 1700

EUROPE: Data Requests: MICROELECTRONICS GROUP DATALINE: **Tel. (44) 7000 582 368**, FAX (44) 1189 328 148

Technical Inquiries: GERMANY: **(49) 89 95086 0** (Munich), UNITED KINGDOM: **(44) 1344 865 900** (Ascot),
FRANCE: **(33) 1 40 83 68 00** (Paris), SWEDEN: **(46) 8 594 607 00** (Stockholm), FINLAND: **(358) 9 4354 2800** (Helsinki),
ITALY: **(39) 02 6608131** (Milan), SPAIN: **(34) 1 807 1441** (Madrid)

Lucent Technologies Inc. reserves the right to make changes to the product(s) or information contained herein without notice. No liability is assumed as a result of their use or application. No rights under any patent accompany the sale of any such product(s) or information.

Copyright © 1999 Lucent Technologies Inc.
All Rights Reserved
Printed in U.S.A.

December 1999
DS99-058WRF (Replaces DS97-268WRF)

microelectronics group

Lucent Technologies
Bell Labs Innovations

